TEXAS INSTRUMENTS

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PCA9544A
**4-CHANNEL I^{2}C AND SMBus MULTIPLEXER
WITH INTERRUPT LOGIC**

SCPS146A−OCTOBER 2005−REVISED OCTOBER 2005

FEATURES

- **1-of-4 Bidirectional Translating Switches**
- **I^{2}C Bus and SMBus Compatible**
- **Four Active-Low Interrupt Inputs**
- **Active-Low Interrupt Output**
- **Three Address Pins, Allowing up to Eight Devices on the I^{2}C Bus**
- **Channel Selection Via I^{2}C Bus**
- **Power Up With All Switch Channels Deselected**
- **Low R$_{ON}$ Switches**
- **Allows Voltage-Level Translation Between 1.8-V, 2.5-V, 3.3-V, and 5-V Buses**

- **No Glitch on Power Up**
- **Supports Hot Insertion**
- **Low Standby Current**
- **Operating Power-Supply Voltage Range of 2.3 V to 5.5 V**
- **5.5-V Tolerant Inputs**
- **0 to 400-kHz Clock Frequency**
- **Latch-Up Performance Exceeds 100 mA Per JESD 78**
- **ESD Protection Exceeds JESD 22**
  - **– 2000-V Human-Body Model (A114-A)**
  - **– 200-V Machine Model (A115-A)**
  - **– 1000-V Charged-Device Model (C101)**

DESCRIPTION/ORDERING INFORMATION

The PCA9544A is a quad bidirectional translating switch controlled via the I^{2}C bus. The SCL/SDA upstream pair fans out to four downstream pairs, or channels. One SCL/SDA pair can be selected at a time, and this is determined by the contents of the programmable control register. Four interrupt inputs ($\overline{INT3}$–$\overline{INT0}$), one for each of the downstream pairs, are provided. One interrupt output ($\overline{INT}$) acts as an AND of the four interrupt inputs.

A power-on reset function puts the registers in their default state and initializes the I^{2}C state machine, with no channel selected.

The pass gates of the switches are constructed such that the V$_{CC}$ pin can be used to limit the maximum high voltage, which will be passed by the PCA9544A. This allows the use of different bus voltages on each pair, so that 1.8-V, 2.5-V, or 3.3-V parts can communicate with 5-V parts, without any additional protection. External pullup resistors pull the bus up to the desired voltage level for each channel. All I/O pins are 5-V tolerant.

ORDERING INFORMATION

T$_A$	PACKAGE[1]		ORDERABLE PART NUMBER	TOP-SIDE MARKING
−40°C to 85°C	QFN – RGW	Reel of 3000	PCA9544ARGWR	PREVIEW
	QFN – RGY	Reel of 1000	PCA9544ARGYR	PD544A
	SOIC – DW	Tube of 25	PCA9544ADW	PCA9544A
		Reel of 2000	PCA9544ADWR	
		Reel of 250	PCA9544ADWT	PREVIEW
	TSSOP – PW	Tube of 70	PCA9544APW	PD544A
		Reel of 2000	PCA9544APWR	
		Reel of 250	PCA9544APWT	
	TVSOP – DGV	Reel of 2000	PCA9544ADGVR	PD544A
		Reel of 250	PCA9544ADGVT	PREVIEW
	VFBGA – GQN	Reel of 1000	PCA9544AGQNR	PD544A
	VFBGA – ZQN (Pb-free)	Reel of 1000	PCA9544AZQNR	PD544A

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.
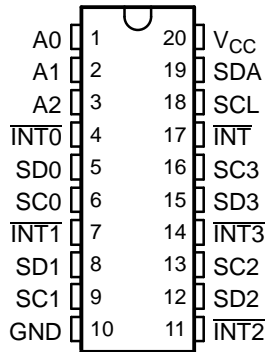
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.
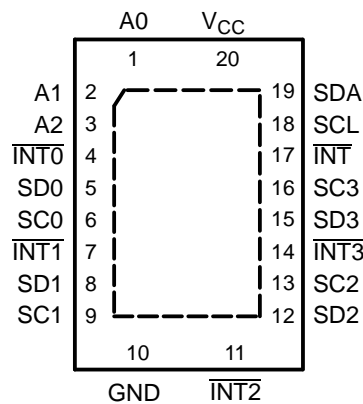
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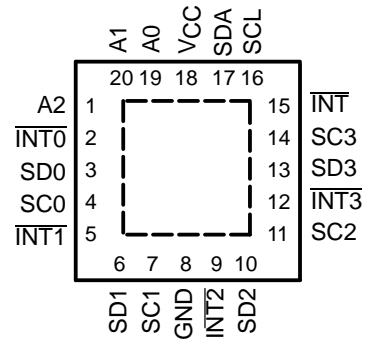## WITH INTERRUPT LOGIC

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DGV, DW, OR PW PACKAGE
(TOP VIEW)

```
        ┌───┐ ┌───┐
   A0 ▯│ 1    20 │▯ V_CC
   A1 ▯│ 2    19 │▯ SDA
   A2 ▯│ 3    18 │▯ SCL
 INT0 ▯│ 4    17 │▯ INT
  SD0 ▯│ 5    16 │▯ SC3
  SC0 ▯│ 6    15 │▯ SD3
 INT1 ▯│ 7    14 │▯ INT3
  SD1 ▯│ 8    13 │▯ SC2
  SC1 ▯│ 9    12 │▯ SD2
  GND ▯│ 10   11 │▯ INT2
        └─────────┘
```
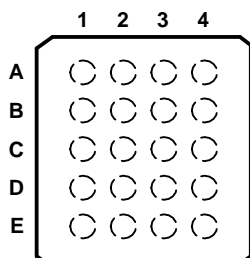
RGY PACKAGE
(TOP VIEW)

```
         A0   V_CC
       ┌───────────┐
       │ 1      20  │
   A1  │ 2      19  │ SDA
   A2  │ 3      18  │ SCL
 INT0  │ 4      17  │ INT
  SD0  │ 5      16  │ SC3
  SC0  │ 6      15  │ SD3
 INT1  │ 7      14  │ INT3
  SD1  │ 8      13  │ SC2
  SC1  │ 9      12  │ SD2
       │ 10     11  │
       └───────────┘
         GND   INT2
```

RGW PACKAGE
(TOP VIEW)

```
           A1 A0 V_CC SDA SCL
           20 19 18  17  16
         ┌──────────────────┐
   A2  1 │                 15│ INT
 INT0  2 │                 14│ SC3
  SD0  3 │                 13│ SD3
  SC0  4 │                 12│ INT3
 INT1  5 │                 11│ SC2
         └──────────────────┘
           6  7  8  9  10
          SD1 SC1 GND INT2 SD2
```

PIN DESCRIPTION

PIN NO.		NAME	FUNCTION
DGV, DW, PW, AND RGY	RGW		
1	19	A0	Address input 0
2	20	A1	Address input 1
3	1	A2	Address input 2
4	2	INT0	Active-low interrupt input 0
5	3	SD0	Serial data 0
6	4	SC0	Serial clock 0
7	5	INT1	Active-low interrupt input 1
8	6	SD1	Serial data 1
9	7	SC1	Serial clock 1
10	8	GND	Ground
11	9	INT2	Active-low interrupt input 2
12	10	SD2	Serial data 2
13	11	SC2	Serial clock 2
14	12	INT3	Active-low interrupt input 3
15	13	SD3	Serial data 3
16	14	SC3	Serial clock 3
17	15	INT	Active-low interrupt output
18	16	SCL	Serial clock line
19	17	SDA	Serial data line
20	18	V_CC	Supply power

GQN OR ZQN PACKAGE
(TOP VIEW)

```
        1  2  3  4
      ┌───────────┐
   A  │ ○  ○  ○  ○ │
   B  │ ○  ○  ○  ○ │
   C  │ ○  ○  ○  ○ │
   D  │ ○  ○  ○  ○ │
   E  │ ○  ○  ○  ○ │
      └───────────┘
```

TERMINAL ASSIGNMENTS

	1	2	3	4
A	A1	A0	V_CC	SDA
B	INT0	INT	A2	SCL
C	SC0	SD0	SD3	SC3
D	SD1	SC2	INT1	INT3
E	GND	SC1	INT2	SD2

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BLOCK DIAGRAM

Pin numbers shown are for DGV, DW, PW, and RGY packages.

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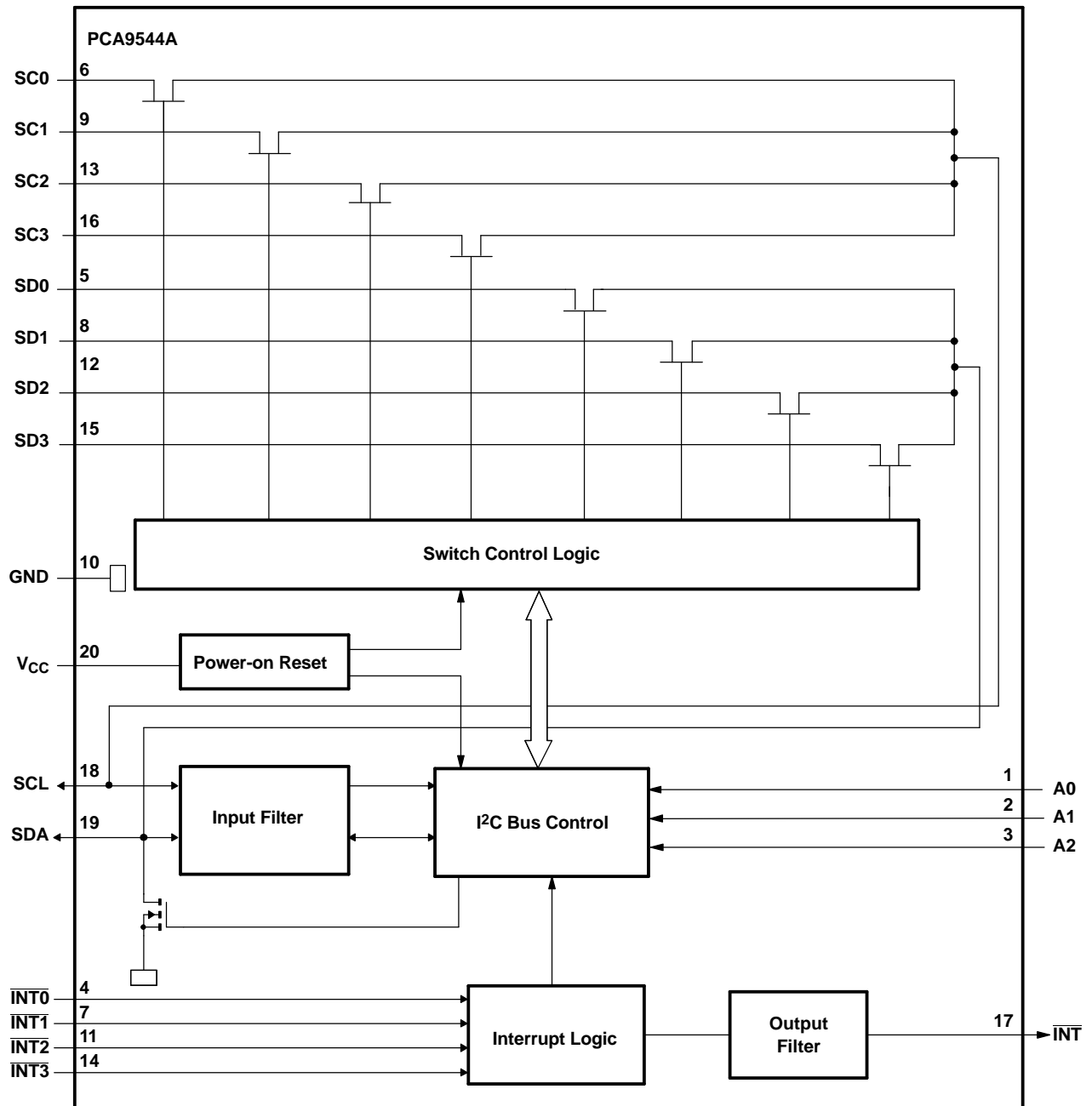
Device Address

Following a start condition, the bus master must output the address of the slave it is accessing. The address of the PCA9544A is shown in Figure 1. To conserve power, no internal pullup resistors are incorporated on the hardware-selectable address pins, and they must be pulled high or low.
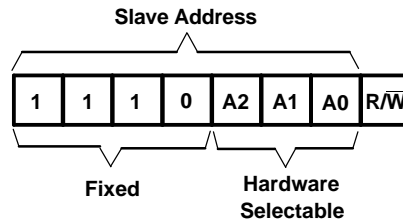

Figure 1. PCA9544A Address

The last bit of the slave address defines the operation to be performed. When set to a logic 1, a read is selected, while a logic 0 selects a write operation.

Control Register

Following the successful acknowledgment of the slave address, the bus master sends a byte to the PCA9544A, which is stored in the control register. If multiple bytes are received by the PCA9544A, it saves the last byte received. This register can be written and read via the I²C bus.
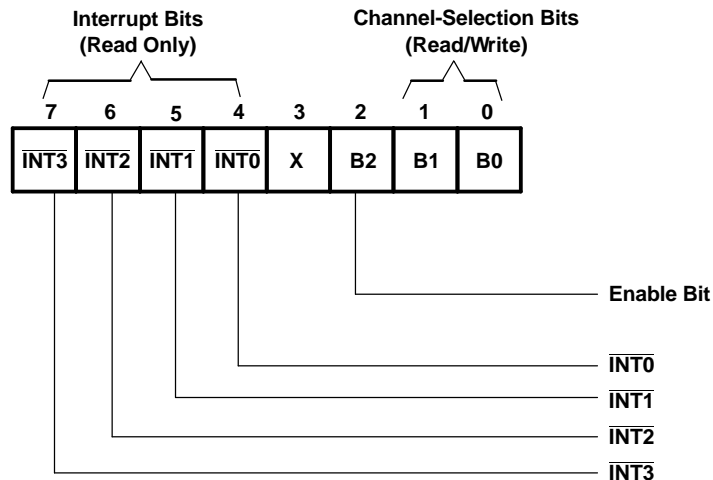

Figure 2. Control Register

Control Register Definition

One or several SCn/SDn downstream pairs, or channels, are selected by the contents of the control register (see Table 1). This register is written after the PCA9544A has been addressed. The three LSBs of the control byte are used to determine which channel (or channels) is to be selected. When a channel is selected, the channel becomes active after a stop condition has been placed on the I²C bus. This ensures that all SCn/SDn lines are in a high state when the channel is made active, so that no false conditions are generated at the time of connection. A stop condition always must occur right after the acknowledge cycle.

Table 1. Control Register Write (Channel Selection), Control Register Read (Channel Status)[1]

$\overline{\text{INT3}}$	$\overline{\text{INT2}}$	$\overline{\text{INT1}}$	$\overline{\text{INT0}}$	D3	B2	B1	B0	COMMAND
X	X	X	X	X	0	X	X	No channel selected
X	X	X	X	X	1	0	0	Channel 0 enabled
X	X	X	X	X	1	0	1	Channel 1 enabled
X	X	X	X	X	1	1	0	Channel 2 enabled
X	X	X	X	X	1	1	1	Channel 3 enabled
0	0	0	0	0	0	0	0	No channel selected, power-up default state

(1) Only one channel may be selected at a time.

Interrupt Handling

The PCA9544A provides four interrupt inputs (one for each channel) and one open-drain interrupt output. When an interrupt is generated by any device, it is detected by the PCA9544A, and the interrupt output is driven low. The channel does not need to be active for detection of the interrupt. A bit also is set in the control register (see Table 2).

Bits 4–7 of the control register correspond to channels 0–3 of the PCA9544A, respectively. Therefore, if an interrupt is generated by any device connected to channel 1, the state of the interrupt inputs is loaded into the control register when a read is accomplished. Likewise, an interrupt on any device connected to channel 0 causes bit 4 of the control register to be set on the read. The master then can address the PCA9544A and read the contents of the control register to determine which channel contains the device generating the interrupt. The master can reconfigure the PCA9544A to select this channel and locate the device generating the interrupt and clear it. Once the device responsible for the interrupt clears, the interrupt clears.

It should be noted that more than one device can provide an interrupt on a channel, so it is up to the master to ensure that all devices on a channel are interrogated for an interrupt.

The interrupt inputs can be used as general-purpose inputs if the interrupt function is not required.

If unused, interrupt input(s) must be connected to V_{CC}.

Table 2. Control Register Read (Interrupt)[1]

$\overline{\text{INT3}}$	$\overline{\text{INT2}}$	$\overline{\text{INT1}}$	$\overline{\text{INT0}}$	D3	B2	B1	B0	COMMAND
X	X	X	0	X	X	X	X	No interrupt on channel 0
X	X	X	1	X	X	X	X	Interrupt on channel 0
X	X	0	X	X	X	X	X	No interrupt on channel 1
X	X	1	X	X	X	X	X	Interrupt on channel 1
X	0	X	X	X	X	X	X	No interrupt on channel 2
X	1	X	X	X	X	X	X	Interrupt on channel 2
0	X	X	X	X	X	X	X	No interrupt on channel 3
1	X	X	X	X	X	X	X	Interrupt on channel 3

(1) Several interrupts can be active at the same time. For example, $\overline{\text{INT3}}$ = 0, $\overline{\text{INT2}}$ = 1, $\overline{\text{INT1}}$ = 1, $\overline{\text{INT0}}$ = 0 means that there is no interrupt on channels 0 and 3, and there is interrupt on channels 1 and 2.

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Power-On Reset

When power is applied to V_{CC}, an internal power-on reset holds the PCA9544A in a reset condition until V_{CC} has reached V_{POR}. At this point, the reset condition is released, and the PCA9544A registers and I²C state machine are initialized to their default states, all zeroes, causing all the channels to be deselected. Thereafter, V_{CC} must be lowered below 0.2 V to reset the device.

Voltage Translation

The pass-gate transistors of the PCA9544A are constructed such that the V_{CC} voltage can be used to limit the maximum voltage that is passed from one I²C bus to another.

Figure 3 shows the voltage characteristics of the pass-gate transistors (note that the graph was generated using data specified in the electrical characteristics section of this data sheet). In order for the PCA9544A to act as a voltage translator, the V_{pass} voltage must be equal to or lower than the lowest bus voltage. For example, if the main bus is running at 5 V and the downstream buses are 3.3 V and 2.7 V, V_{pass} must be equal to or below 2.7 V to effectively clamp the downstream bus voltages. As shown in Figure 3, V_{pass} (max) is at 2.7 V when the PCA9544A supply voltage is 3.5 V or lower, so the PCA9544A supply voltage could be set to 3.3 V. Pullup resistors then can be used to bring the bus voltages to their appropriate levels (see Figure 12).
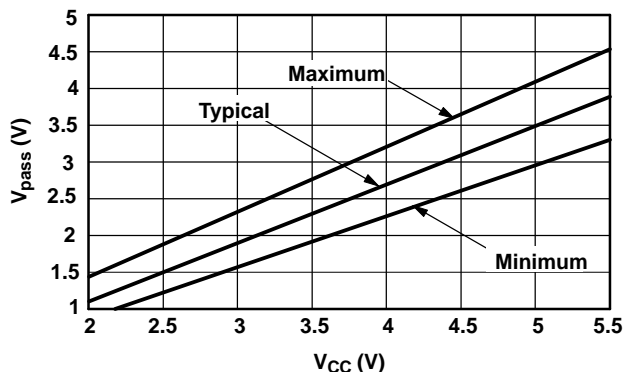

Figure 3. V_{pass} Voltage vs V_{CC}

I²C Interface

The I²C bus is for two-way two-line communication between different ICs or modules. The two lines are a serial data line (SDA) and a serial clock line (SCL). Both lines must be connected to a positive supply via a pullup resistor when connected to the output stages of a device. Data transfer can be initiated only when the bus is not busy.

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the high period of the clock pulse, as changes in the data line at this time are interpreted as control signals (see Figure 4).
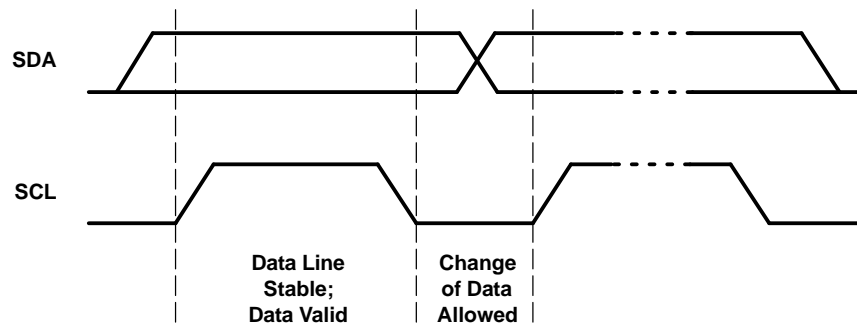
Figure 4. Bit Transfer

Both data and clock lines remain high when the bus is not busy. A high-to-low transition of the data line while the clock is high is defined as the start condition (S). A low-to-high transition of the data line while the clock is high is defined as the stop condition (P) (see Figure 5).
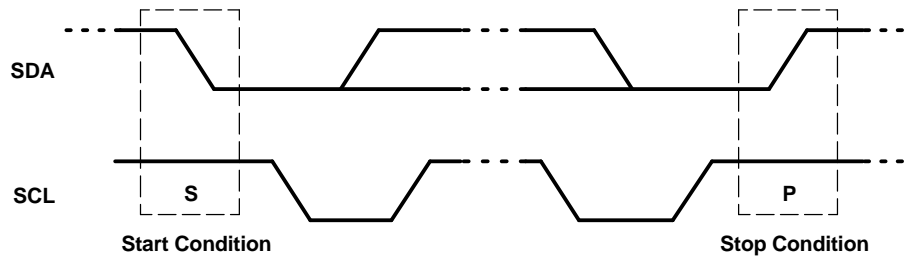

Figure 5. Definition of Start and Stop Conditions

A device generating a message is a transmitter; a device receiving a message is the receiver. The device that controls the message is the master, and the devices that are controlled by the master are the slaves (see Figure 6).
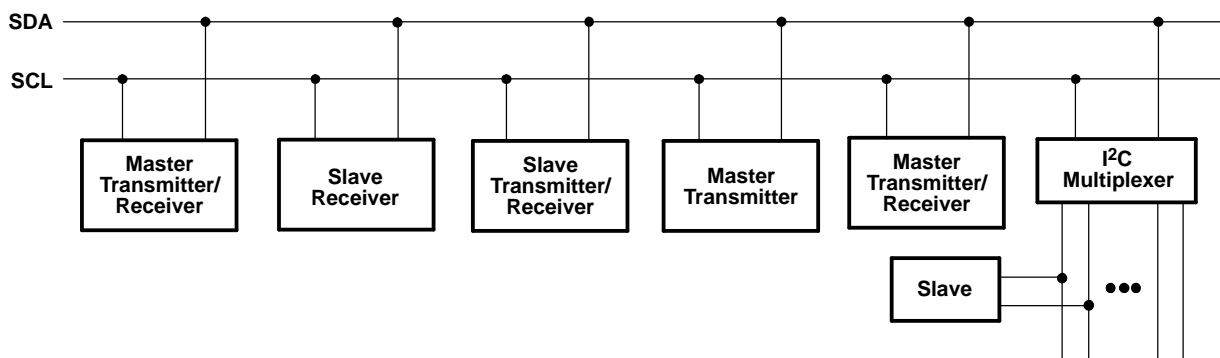

Figure 6. System Configuration

The number of data bytes transferred between the start and the stop conditions from transmitter to receiver is not limited. Each byte of eight bits is followed by one ACK bit. The transmitter must release the SDA line before the receiver can send an ACK bit.

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When a slave receiver is addressed, it must generate an acknowledge (ACK) after the reception of each byte. Also, a master must generate an ACK after the reception of each byte that has been clocked out of the slave transmitter. The device that acknowledges must pull down the SDA line during the ACK clock pulse so that the SDA line is stable low during the high pulse of the ACK-related clock period (see Figure 7). Setup and hold times must be taken into account.
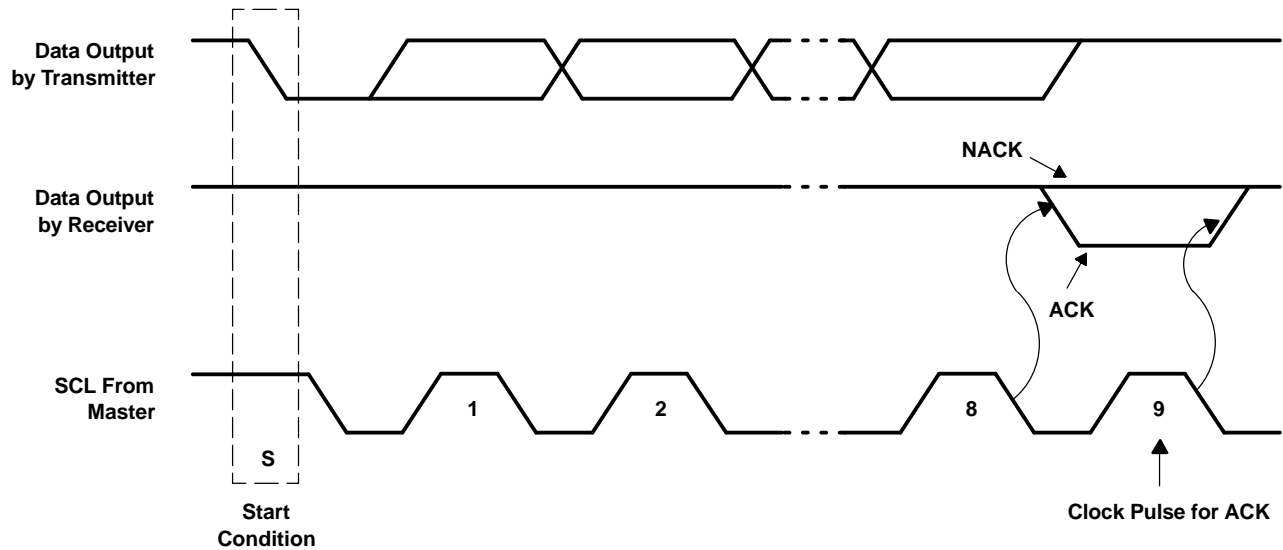

Figure 7. Acknowledgment on the I²C Bus

A master receiver must signal an end of data to the transmitter by not generating an acknowledge (NACK) after the last byte has been clocked out of the slave. This is done by the master receiver by holding the SDA line high. In this event, the transmitter must release the data line to enable the master to generate a stop condition.

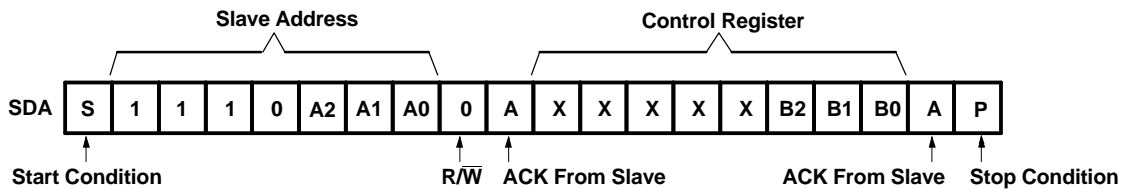Data is transmitted to the PCA9544A control register using the write mode shown in Figure 8.

Figure 8. Write Control Register

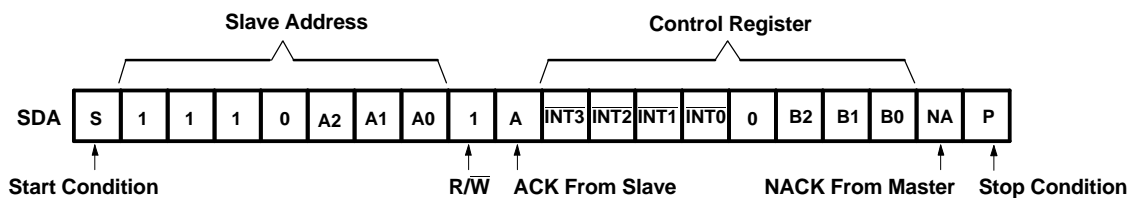Data is read from the PCA9544A control register using the read mode shown in Figure 9.

Figure 9. Read Control Register

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Absolute Maximum Ratings[1]

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V_{CC}	Supply voltage range		−0.5	7	V
V_I	Input voltage range[2]		−0.5	7	V
I_I	Input current			±20	mA
I_O	Output current			±25	mA
	Continuous current through V_{CC}			±100	mA
	Continuous current through GND			±100	mA
θ_{JA}	Package thermal impedance	DGV package[3]		92	°C/W
		DW package[3]		58	
		GQN package[3]		78	
		PW package[3]		83	
		RGW package[4]		TBD	
		RGY package[4]		37	
P_{tot}	Total power dissipation			400	mW
T_{stg}	Storage temperature range		−65	150	°C
T_A	Operating free-air temperature range		−40	85	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
(2) The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
(3) The package thermal impedance is calculated in accordance with JESD 51-7.
(4) The package thermal impedance is calculated in accordance with JESD 51-5.

Recommended Operating Conditions[1]

			MIN	MAX	UNIT
V_{CC}	Supply voltage		2.3	5.5	V
V_{IH}	High-level input voltage	SCL, SDA	$0.7 \times V_{CC}$	6	V
		A2–A0, $\overline{INT3}$–$\overline{INT0}$	$0.7 \times V_{CC}$	$V_{CC} + 0.5$	
V_{IL}	Low-level input voltage	SCL, SDA	−0.5	$0.3 \times V_{CC}$	V
		A2–A0, $\overline{INT3}$–$\overline{INT0}$	−0.5	$0.3 \times V_{CC}$	
T_A	Operating free-air temperature		−40	85	°C

(1) All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

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Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS		V_{CC}	MIN	TYP[1]	MAX	UNIT
V_{POR}	Power-on reset voltage [2]		No load,	$V_I = V_{CC}$ or GND	V_{POR}		1.7	2.1	V
V_{pass}	Switch output voltage		$V_{SWin} = V_{CC}$,	$I_{SWout} = -100$ μA	5 V		3.6		V
					4.5 V to 5.5 V	2.6		4.5	
					3.3 V		1.9		
					3 V to 3.6 V	1.6		2.8	
					2.5 V		1.5		
					2.3 V to 2.7 V	1.1		2	
I_{OH}	$\overline{INT}$		$V_O = V_{CC}$		2.3 V to 5.5 V			10	μA
I_{OL}	SCL, SDA		$V_{OL} = 0.4$ V		2.3 V to 5.5 V	3	7		mA
			$V_{OL} = 0.6$ V			6	10		
	$\overline{INT}$		$V_{OL} = 0.4$ V			3	7		
I_I	SCL, SDA		$V_I = V_{CC}$ or GND		2.3 V to 5.5 V			±1	μA
	SC3–SC0, SD3–SD0							±1	
	A2–A0							±1	
	$\overline{INT3}$–$\overline{INT0}$							±1	
I_{CC}	Operating mode	$f_{SCL} = 100$ kHz	$V_I = V_{CC}$ or GND,	$I_O = 0$	5.5 V		3	12	μA
					3.6 V		3	11	
					2.7 V		3	10	
	Standby mode	Low inputs	$V_I = $ GND,	$I_O = 0$	5.5 V		0.3	1	
					3.6 V		0.1	1	
					2.7 V		0.1	1	
		High inputs	$V_I = V_{CC}$,	$I_O = 0$	5.5 V		0.3	1	
					3.6 V		0.1	1	
					2.7 V		0.1	1	
ΔI_{CC}	Supply-current change	$\overline{INT3}$–$\overline{INT0}$	One $\overline{INT3}$–$\overline{INT0}$ input at 0.6 V, Other inputs at V_{CC} or GND		2.3 V to 5.5 V		8	15	μA
			One $\overline{INT3}$–$\overline{INT0}$ input at $V_{CC} - 0.6$ V, Other inputs at V_{CC} or GND				8	15	
		SCL, SDA	SCL or SDA input at 0.6 V, Other inputs at V_{CC} or GND				8	15	
			SCL or SDA inputs at $V_{CC} - 0.6$ V, Other inputs at V_{CC} or GND				8	15	
C_i	A2–A0		$V_I = V_{CC}$ or GND		2.3 V to 5.5 V		4.5	6	pF
	$\overline{INT3}$–$\overline{INT0}$						4.5	6	
$C_{io(OFF)}$ [3]	SCL, SDA		$V_I = V_{CC}$ or GND,	Switch OFF	2.3 V to 5.5 V		15	19	pF
	SC3–SC0, SD3–SD0						6	8	
R_{ON}	Switch-on resistance		$V_O = 0.4$ V,	$I_O = 15$ mA	4.5 V to 5.5 V	4	9	16	Ω
					3 V to 3.6 V	5	11	20	
			$V_O = 0.4$ V,	$I_O = 10$ mA	2.3 V to 2.7 V	7	16	45	

(1) All typical values are at nominal supply voltage (2.5-V, 3.3-V, or 5-V V_{CC}), $T_A = 25°$C.
(2) The power-on reset circuit resets the I²C bus logic with $V_{CC} < V_{POR}$. V_{CC} must be lowered to 0.2 V to reset the device.
(3) $C_{io(ON)}$ depends on internal capacitance and external capacitance added to the SCn lines when channels(s) are ON.

I²C Interface Timing Requirements

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 12)

		STANDARD-MODE I²C BUS		FAST-MODE I²C BUS		UNIT
		MIN	MAX	MIN	MAX	
f_{scl}	I²C clock frequency	0	100	0	400	kHz
t_{sch}	I²C clock high time	4		0.6		µs
t_{scl}	I²C clock low time	4.7		1.3		µs
t_{sp}	I²C spike time		50		50	ns
t_{sds}	I²C serial-data setup time	250		100		ns
t_{sdh}	I²C serial-data hold time	0[1]		0[1]		µs
t_{icr}	I²C input rise time		1000	$20 + 0.1C_b$[2]	300	ns
t_{icf}	I²C input fall time		300	$20 + 0.1C_b$[2]	300	ns
t_{ocf}	I²C output fall time (10-pF to 400-pF bus)		300	$20 + 0.1C_b$[2]	300	ns
t_{buf}	I²C bus free time between stop and start	4.7		1.3		µs
t_{sts}	I²C start or repeated start condition setup	4.7		0.6		µs
t_{sth}	I²C start or repeated start condition hold	4		0.6		µs
t_{sps}	I²C stop condition setup	4		0.6		µs
$t_{vdL(Data)}$	Valid-data time (high to low)[3] — SCL low to SDA output low valid	1		1		µs
$t_{vdH(Data)}$	Valid-data time (low to high)[3] — SCL low to SDA output high valid	0.6		0.6		µs
$t_{vd(ack)}$	Valid-data time of ACK condition — ACK signal from SCL low to SDA output low	1		1		µs
C_b	I²C bus capacitive load		400		400	pF

(1) A device internally must provide a hold time of at least 300 ns for the SDA signal (referred to as the V_{IH} min of the SCL signal), in order to bridge the undefined region of the falling edge of SCL.
(2) C_b = total bus capacitance of one bus line in pF
(3) Data taken using a 1-kΩ pullup resistor and 50-pF load (see Figure 10).

Switching Characteristics

over recommended operating free-air temperature range, $C_L \le 100$ pF (unless otherwise noted) (see Figure 10)

PARAMETER			FROM (INPUT)	TO (OUTPUT)	MIN	MAX	UNIT
t_{pd}[1]	Propagation delay time	$R_{ON} = 20\ \Omega$, $C_L = 15$ pF	SDA or SCL	SDn or SCn		0.3	µs
		$R_{ON} = 20\ \Omega$, $C_L = 50$ pF				1	
t_{iv}	Interrupt valid time[2]		$\overline{INTn}$	$\overline{INT}$		4	µs
t_{ir}	Interrupt reset delay time[2]		$\overline{INTn}$	$\overline{INT}$		2	µs

(1) The propagation delay is the calculated RC time constant of the typical ON-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).
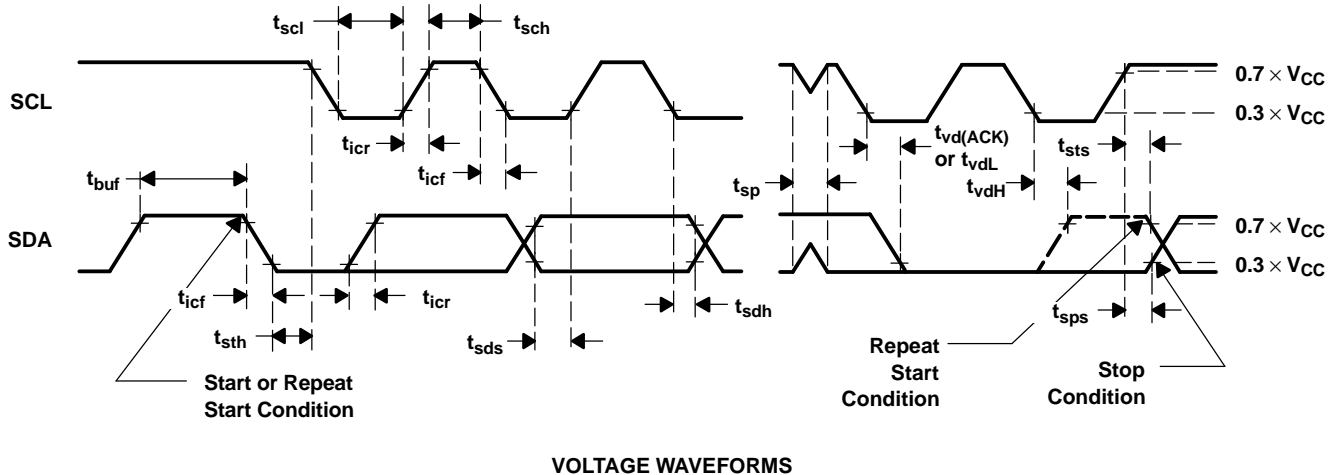(2) Data taken using a 4.7-kΩ pullup resistor and 100-pF load (see Figure 11).

Interrupt Timing Requirements

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		MIN	MAX	UNIT
t_{PWRL}	Low-level pulse duration rejection of $\overline{INTn}$ inputs[1]	1		µs
t_{PWRH}	High-level pulse duration rejection of $\overline{INTn}$ inputs[1]	0.5		µs

(1) Data taken using a 4.7-kΩ pullup resistor and 100-pF load (see Figure 11).

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PARAMETER MEASUREMENT INFORMATION

V$_{CC}$

R$_L$ = 1 kΩ

DUT   SDn, SCn

C$_L$ = 50 pF
(See Note A)

I²C-PORT LOAD CONFIGURATION

**Two Bytes for Complete
Device Programming**

| Stop Condition (P) | Start Condition (S) | Address Bit 7 (MSB) | Address Bit 6 | ••• | Address Bit 1 | R/$\overline{W}$ Bit 0 (LSB) | ACK (A) | Data Bit 7 (MSB) | ••• | Data Bit 0 (LSB) | ACK (A) | Stop Condition (P) |

BYTE	DESCRIPTION
1	I²C address + R/$\overline{W}$
2	Control register data

VOLTAGE WAVEFORMS
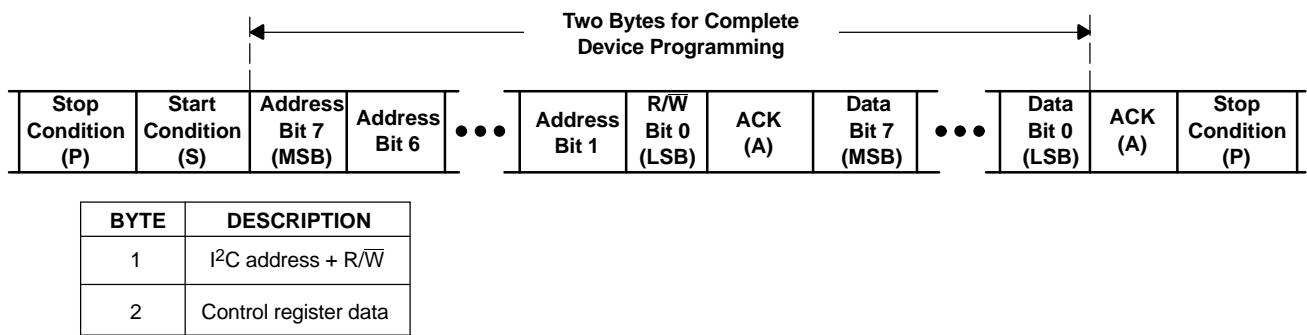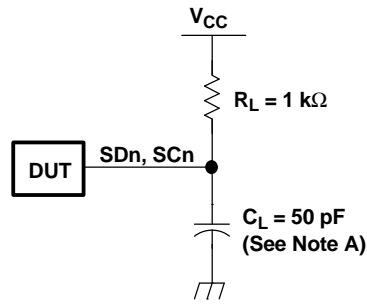
NOTES: A. C$_L$ includes probe and jig capacitance.
B. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z$_O$ = 50 Ω, t$_r$/t$_f$ ≤ 30 ns.
C. The outputs are measured one at a time, with one transition per measurement.

Figure 10. I²C Interface Load Circuit, Byte Descriptions, and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION (continued)

INTERRUPT LOAD CONFIGURATION

VOLTAGE WAVEFORMS (t$_{iv}$)

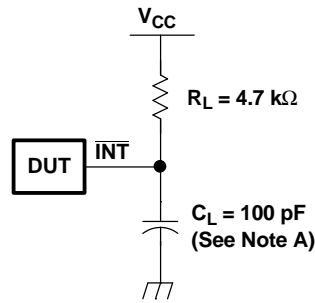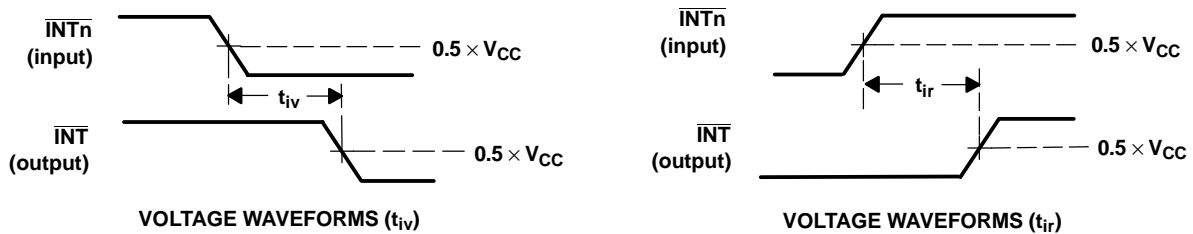**VOLTAGE WAVEFORMS (t$_{ir}$)**
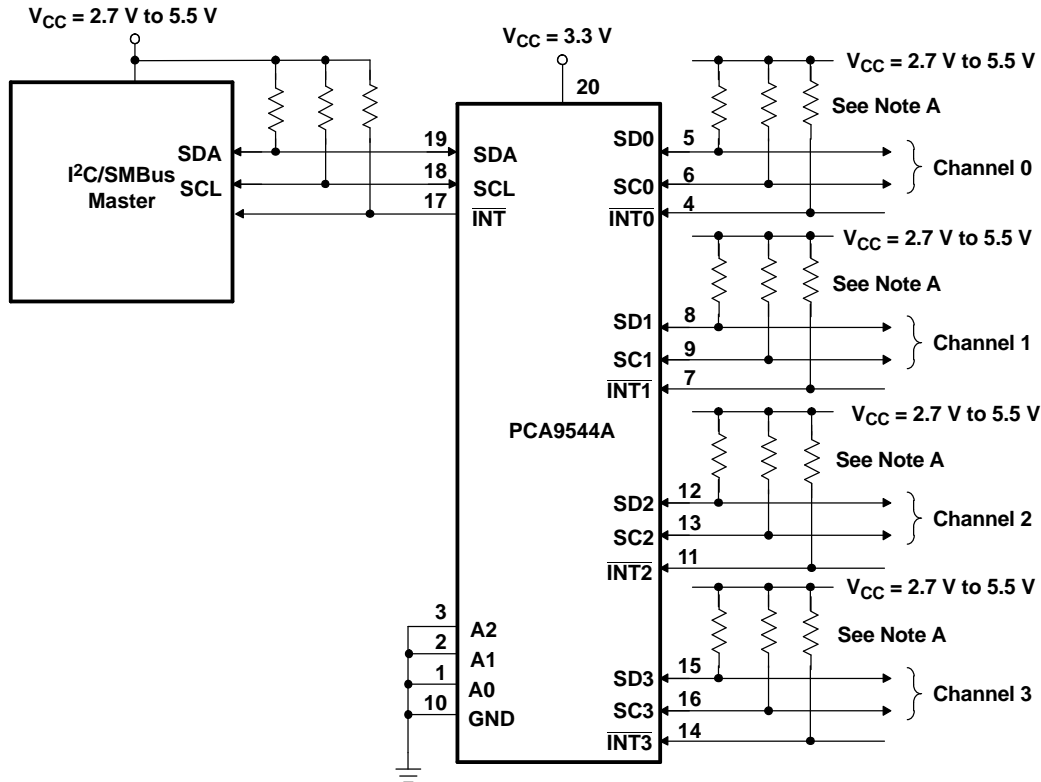
NOTES: A. C$_L$ includes probe and jig capacitance.
B. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z$_O$ = 50 Ω, t$_r$/t$_f$ ≤ 30 ns.

Figure 11. Interrupt Load Circuit and Voltage Waveforms

PCA9544A
4-CHANNEL I²C AND SMBus MULTIPLEXER
WITH INTERRUPT LOGIC
SCPS146A−OCTOBER 2005−REVISED OCTOBER 2005

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APPLICATION INFORMATION

Figure 12. Typical Application

NOTES: A. If the device generating the interrupt has an open-drain output structure or can be 3-stated, a pullup resistor is required.
If the device generating the interrupt has a totem-pole output structure and cannot be 3-stated, a pullup resistor is not required.
The interrupt inputs should not be left floating.

B. Pin numbers shown are for DGV, DW, PW, and RGY packages.

PACKAGING INFORMATION

Orderable Device	Status [1]	Package Type	Package Drawing	Pins	Package Qty	Eco Plan [2]	Lead/Ball Finish	MSL Peak Temp [3]
PCA9544ADGVR	PREVIEW	TVSOP	DGV	20	2000	TBD	Call TI	Call TI
PCA9544ADGVT	PREVIEW	TVSOP	DGV	20	250	TBD	Call TI	Call TI
PCA9544ADW	PREVIEW	SOIC	DW	20	25	TBD	Call TI	Call TI
PCA9544ADWR	PREVIEW	SOIC	DW	20	2000	TBD	Call TI	Call TI
PCA9544ADWT	PREVIEW	SOIC	DW	20	250	TBD	Call TI	Call TI
PCA9544AGQNR	PREVIEW	VFBGA	GQN	20	1000	TBD	Call TI	Call TI
PCA9544APW	PREVIEW	TSSOP	PW	20	70	TBD	Call TI	Call TI
PCA9544APWR	PREVIEW	TSSOP	PW	20	2000	TBD	Call TI	Call TI
PCA9544APWT	PREVIEW	TSSOP	PW	20	250	TBD	Call TI	Call TI
PCA9544ARGWR	PREVIEW	QFN	RGW	20	3000	TBD	Call TI	Call TI
PCA9544ARGYR	PREVIEW	QFN	RGY	20	1000	TBD	Call TI	Call TI
PCA9544AZQNR	PREVIEW	VFBGA	ZQN	20	1000	TBD	Call TI	Call TI

[1] The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

[2] Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)
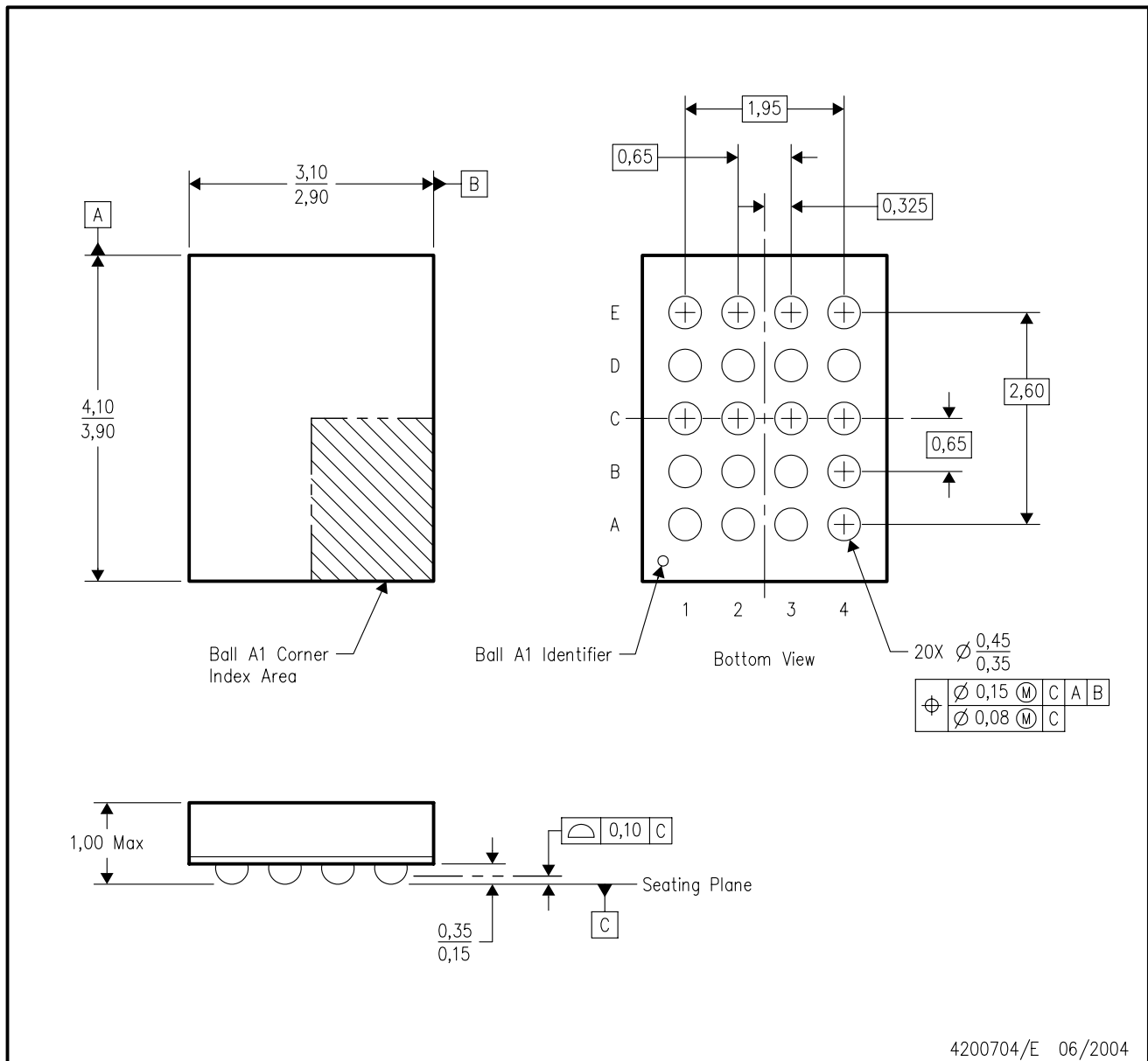
[3] MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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GQN (R–PBGA–N20)　　　　　　　　PLASTIC BALL GRID ARRAY

Ball A1 Corner
Index Area

Ball A1 Identifier

Bottom View

20X ⌀ $\frac{0,45}{0,35}$

⌖	⌀ 0,15 Ⓜ	C	A	B
	⌀ 0,08 Ⓜ	C		

1,00 Max

Seating Plane

$\frac{0,35}{0,15}$

4200704/E 06/2004

NOTES:　A.　All linear dimensions are in millimeters.
　　　　　B.　This drawing is subject to change without notice.
　　　　　C.　Falls within JEDEC MO–225 variation BC.
　　　　　D.　This package is tin–lead (SnPb). Refer to the 20 ZQN package (drawing 4204492) for lead–free.

ZQN (R−PBGA−N20)　　　　PLASTIC BALL GRID ARRAY

Ball A1 Corner
Index Area

Ball A1 Identifier

Bottom View

20X Ø 0,45 / 0,35

⊕	Ø 0,15 Ⓜ	C	A	B
	Ø 0,08 Ⓜ	C		

3,10 / 2,90

4,10 / 3,90

1,95
0,65
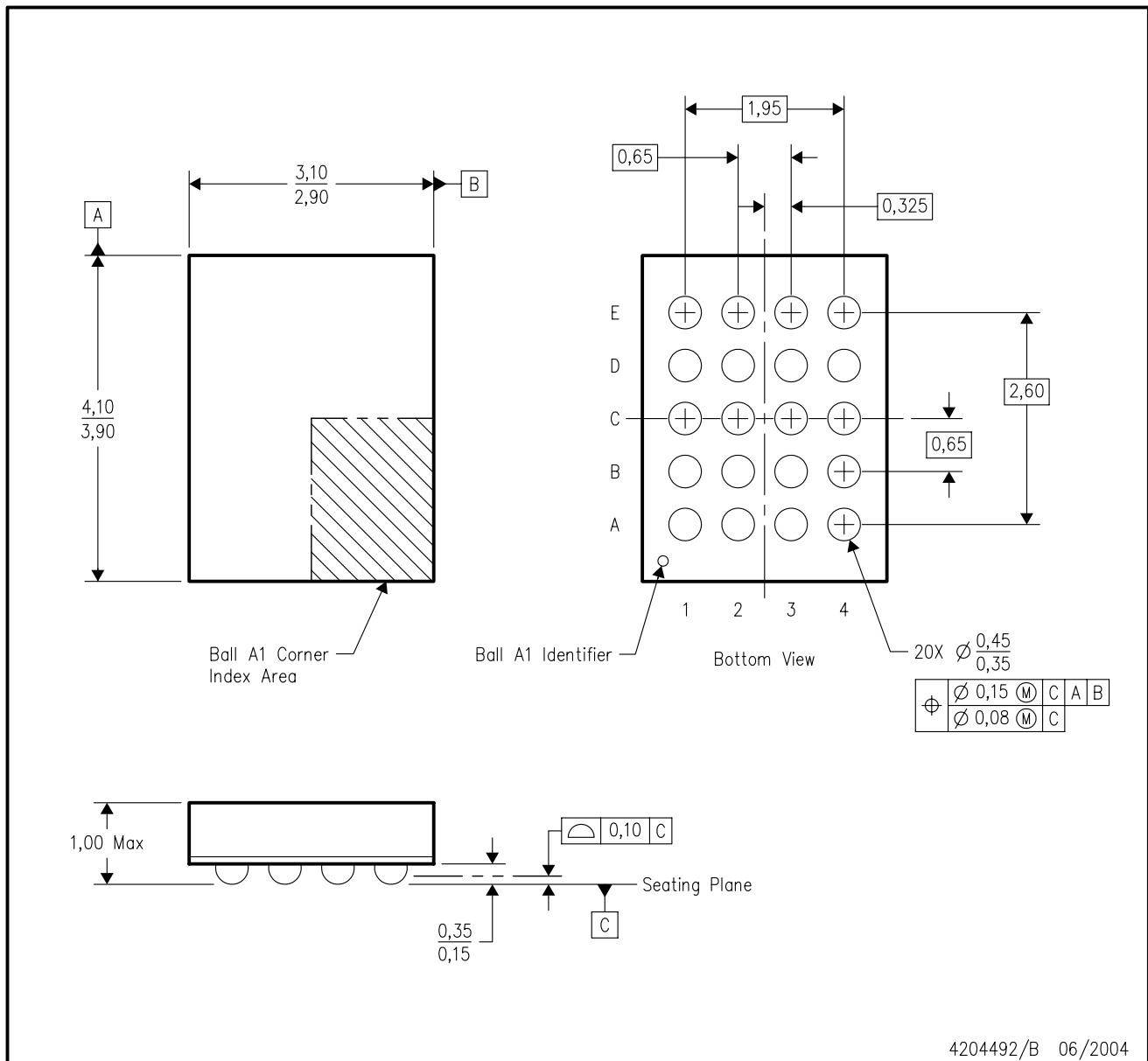0,325
2,60
0,65

1,00 Max

Seating Plane

0,35 / 0,15

0,10 C

4204492/B 06/2004

NOTES:　A.　All linear dimensions are in millimeters.
　　　　　B.　This drawing is subject to change without notice.
　　　　　C.　Falls within JEDEC MO−225 variation BC.
　　　　　D.　This package is lead−free. Refer to the 20 GQN package (drawing 4200704) for tin−lead (SnPb).

DGV (R-PDSO-G**)   **PLASTIC SMALL-OUTLINE**

24 PINS SHOWN

DIM \ PINS **	14	16	20	24	38	48	56
A MAX	3,70	3,70	5,10	5,10	7,90	9,80	11,40
A MIN	3,50	3,50	4,90	4,90	7,70	9,60	11,20

4073251/E 08/00

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
D. Falls within JEDEC: 24/48 Pins – MO-153
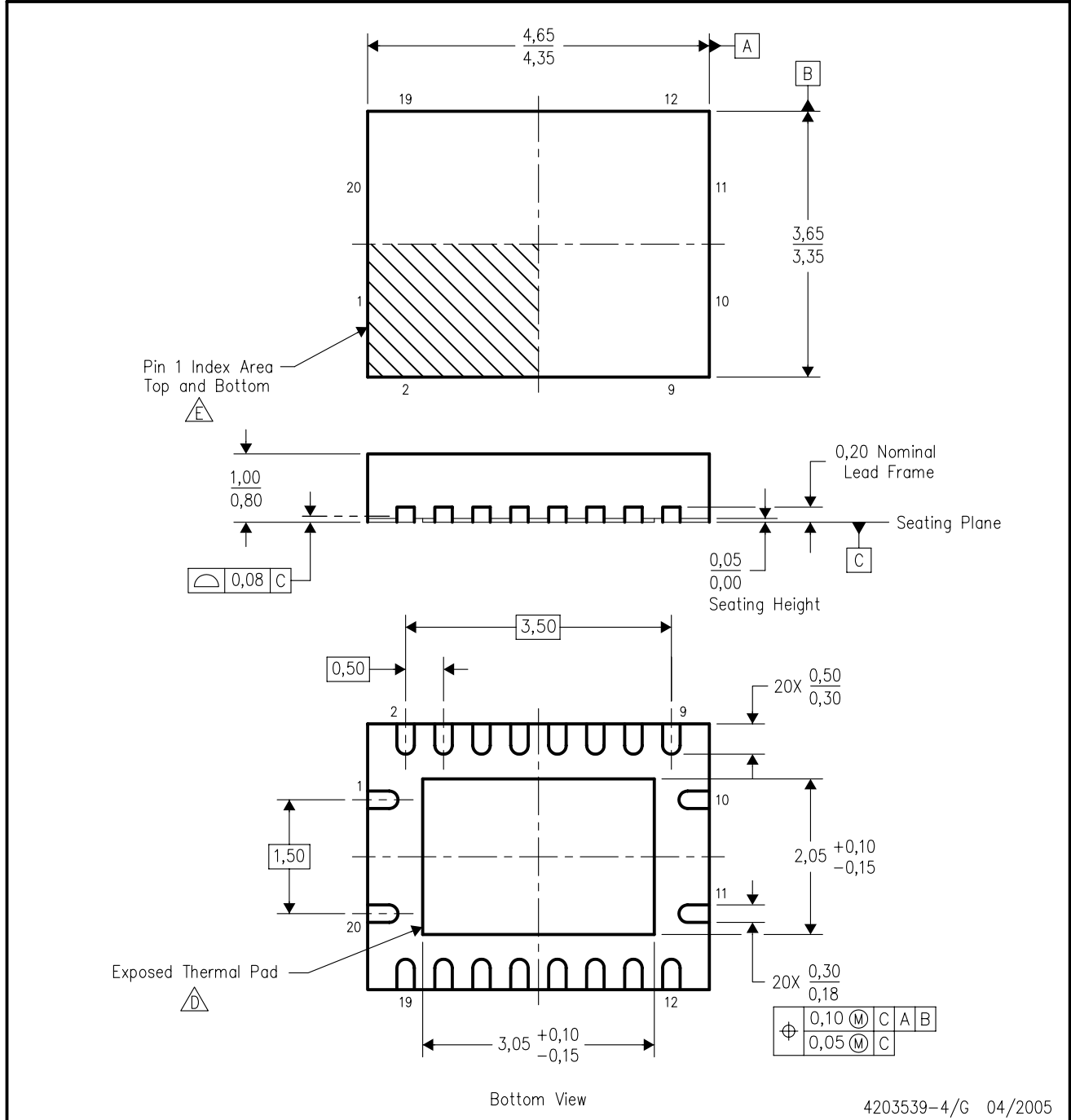   14/16/20/56 Pins – MO-194

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DW (R–PDSO–G20)   PLASTIC SMALL–OUTLINE PACKAGE

$\dfrac{0.512\ (13,00)}{0.496\ (12,60)}$

20   11

$\dfrac{0.419\ (10,63)}{0.393\ (9,97)}$

$\dfrac{0.299\ (7,60)}{0.291\ (7,40)}$

1   10

Pin 1
Index Area

0.050 (1,27)

$\dfrac{0.020\ (0,51)}{0.012\ (0,31)}$

⊕ 0.010 (0,25) Ⓜ

0.104 (2,65) Max

$\dfrac{0.012\ (0,30)}{0.004\ (0,10)}$

$\dfrac{0.013\ (0,33)}{0.008\ (0,20)}$

⌒ 0.004 (0,10)

Gauge Plane

Seating Plane

0.010 (0,25)   0°–8°

$\dfrac{0.050\ (1,27)}{0.016\ (0,40)}$

4040000–4/F 06/2004

NOTES: A. All linear dimensions are in inches (millimeters).
          B. This drawing is subject to change without notice.
          C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
          D. Falls within JEDEC MS–013 variation AC.

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RGY (R−PQFP−N20)
PLASTIC QUAD FLATPACK

Pin 1 Index Area
Top and Bottom
⚠E

0,20 Nominal
Lead Frame

Seating Plane

1,00 / 0,80

⌒ 0,08 C

0,05 / 0,00
Seating Height

3,50

0,50

20X 0,50 / 0,30

20X 0,30 / 0,18

1,50

2,05 +0,10 / −0,15

Exposed Thermal Pad
⚠D

3,05 +0,10 / −0,15

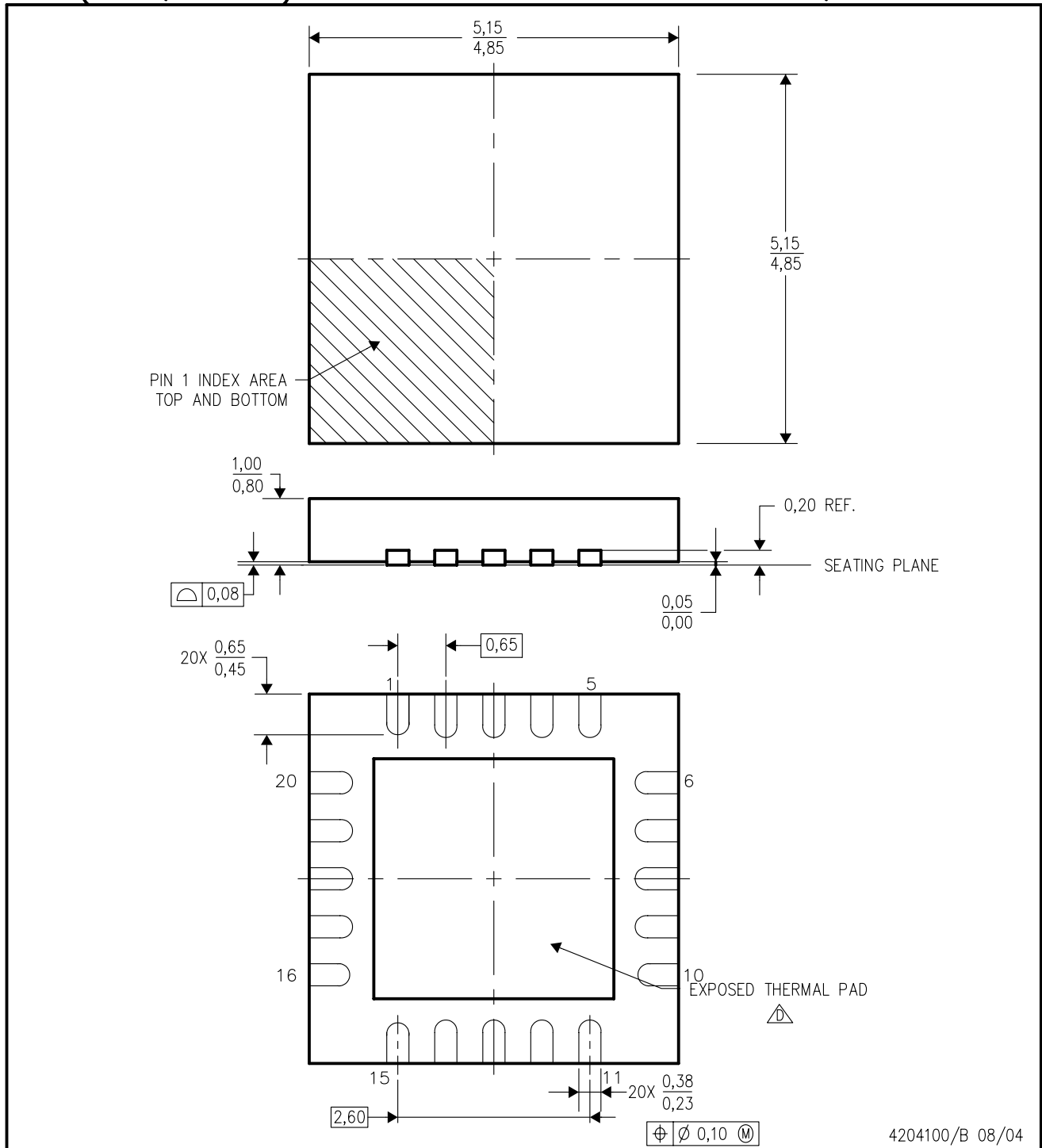| ⊕	0,10 Ⓜ	C	A	B
	0,05 Ⓜ	C		

Bottom View

4203539−4/G 04/2005

NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M−1994.
        B. This drawing is subject to change without notice.
        C. QFN (Quad Flatpack No−Lead) package configuration.
    ⚠D The package thermal pad must be soldered to the board for thermal and mechanical performance.
    ⚠E Pin 1 identifiers are located on both top and bottom of the package and within the zone indicated.
        The Pin 1 identifiers are either a molded, marked, or metal feature.
        F. Package complies to JEDEC MO−241 variation BC.

RGW (S−PQFP−N20)   **PLASTIC QUAD FLATPACK**

$\frac{5,15}{4,85}$

$\frac{5,15}{4,85}$

PIN 1 INDEX AREA
TOP AND BOTTOM

$\frac{1,00}{0,80}$

0,20 REF.

SEATING PLANE

△ 0,08

$\frac{0,05}{0,00}$

20X $\frac{0,65}{0,45}$

0,65

1

5

20

6

16

10
EXPOSED THERMAL PAD
⚠ D

15

11

20X $\frac{0,38}{0,23}$

2,60

⊕ ⌀ 0,10 Ⓜ

4204100/B 08/04

NOTES:
A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5−1994.
B. This drawing is subject to change without notice.
C. Quad Flat pack, No−leads (QFN) package configuration
⚠ The package thermal pad must be soldered to the board for thermal and mechanical performance..
See the Product Data Sheet for details regarding the exposed thermal pad dimensions.
E. Falls within JEDEC MO−220.

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PW (R-PDSO-G**)　　　　　　　　　　　　　　　　**PLASTIC SMALL-OUTLINE PACKAGE**

14 PINS SHOWN

0,65

$\frac{0,30}{0,19}$　⊕　0,10　Ⓜ

14　　　8

$\frac{4,50}{4,30}$　$\frac{6,60}{6,20}$

1　　　7

A

0,15 NOM

Gage Plane

0°−8°

0,25

$\frac{0,75}{0,50}$

1,20 MAX　　$\frac{0,15}{0,05}$

Seating Plane

⌒　0,10

DIM ＼ PINS **	8	14	16	20	24	28
A MAX	3,10	5,10	5,10	6,60	7,90	9,80
A MIN	2,90	4,90	4,90	6,40	7,70	9,60

4040064/F 01/97

NOTES:　A.　All linear dimensions are in millimeters.
　　　　　B.　This drawing is subject to change without notice.
　　　　　C.　Body dimensions do not include mold flash or protrusion not to exceed 0,15.
　　　　　D.　Falls within JEDEC MO-153

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